

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	2376730	(solder\$4 or braz\$4 or filler or connect\$4 or insert or adhesive) and ((la or lanthanum or lanthide) near (al or aluminum or ni or nickel) or LaNi or LaNi5 or "LaNi.sub.5" or "LaNi4.5Al0.5" or LaNiAl "LaNi.sub.4.5Al.sub.0.5" or TiZrMnVNi or "La0.88Zr0.12Mn1.0V0.4Ni0.6" or "La.sub.0.88Zr.sub.0.12Mn.sub.1.0V.sub.0.4Ni.sub.0.6" or LaNiMn or "LaNi4.5Mn0.5" or "LaNi.sub.4.5Mn.sub.0.5" or MgNi or Mg2Ni or "Mg.sub.2Ni" or "V" OR Vanadium or zr or zirconium)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/03/27 14:14
L2	23109	1 and (solder\$4 or braz\$4 or filler or connect\$4 or insert or adhesive) near ((la or lanthanum or lanthide) near (al or aluminum or ni or nickel) or LaNi or LaNi5 or "LaNi.sub.5" or "LaNi4.5Al0.5" or LaNiAl "LaNi.sub.4.5Al.sub.0.5" or TiZrMnVNi or "La0.88Zr0.12Mn1.0V0.4Ni0.6" or "La.sub.0.88Zr.sub.0.12Mn.sub.1.0V.sub.0.4Ni.sub.0.6" or LaNiMn or "LaNi4.5Mn0.5" or "LaNi.sub.4.5Mn.sub.0.5" or MgNi or Mg2Ni or "Mg.sub.2Ni" or "V" OR Vanadium or zr or zirconium)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/03/27 14:15
L3	1883	2 and (solder\$4 or braz\$4 or filler or adhesive) near ((la or lanthanum or lanthide) near (al or aluminum or ni or nickel) or LaNi or LaNi5 or "LaNi.sub.5" or "LaNi4.5Al0.5" or LaNiAl "LaNi.sub.4.5Al.sub.0.5" or TiZrMnVNi or "La0.88Zr0.12Mn1.0V0.4Ni0.6" or "La.sub.0.88Zr.sub.0.12Mn.sub.1.0V.sub.0.4Ni.sub.0.6" or LaNiMn or "LaNi4.5Mn0.5" or "LaNi.sub.4.5Mn.sub.0.5" or MgNi or Mg2Ni or "Mg.sub.2Ni" or "V" OR Vanadium or zr or zirconium)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/03/27 14:27
L4	295	3 and (hydrogen or "h.sub.2" or h2)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/03/27 14:25

L5	19	4 and (dispers\$4 or powder or particle or particulate or grain or granula\$5) near ((la or lanthanum or lanthide) near (al or aluminum or ni or nickel) or LaNi or LaNi5 or "LaNi.sub.5" or "LaNi4.5Al0.5" or LaNiAl "LaNi.sub.4.5Al.sub.0.5" or TiZrMnVNi or "La0.88Zr0.12Mn1.0V0.4Ni0.6" or "La.sub.0.88Zr.sub.0.12Mn.sub.1.0V.sub.0.4Ni.sub.0.6" or LaNiMn or "LaNi4.5Mn0.5" or "LaNi.sub.4.5Mn.sub.0.5" or MgNi or Mg2Ni or "Mg.sub.2Ni" or "V" OR Vanadium or zr or zirconium)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/03/27 14:17
L6	49	3 and (dispers\$4 or powder or particle or particulate or grain or granula\$5) near ((la or lanthanum or lanthide) near (al or aluminum or ni or nickel) or LaNi or LaNi5 or "LaNi.sub.5" or "LaNi4.5Al0.5" or LaNiAl "LaNi.sub.4.5Al.sub.0.5" or TiZrMnVNi or "La0.88Zr0.12Mn1.0V0.4Ni0.6" or "La.sub.0.88Zr.sub.0.12Mn.sub.1.0V.sub.0.4Ni.sub.0.6" or LaNiMn or "LaNi4.5Mn0.5" or "LaNi.sub.4.5Mn.sub.0.5" or MgNi or Mg2Ni or "Mg.sub.2Ni" or "V" OR Vanadium or zr or zirconium)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/03/27 14:20
L7	8	6 and (cream or paste)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/03/27 14:20
L8	164	3 and (solder\$4 or braz\$4 or filler or adhesive) near (first or second or (high\$4 or low\$4) near (melt\$4 or temp or temperature) or hmt or hmp or lmt or lmp)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/03/27 14:19
L9	8	8 and (dispers\$4 or powder or particle or particulate or grain or granula\$5) near ((la or lanthanum or lanthide) near (al or aluminum or ni or nickel) or LaNi or LaNi5 or "LaNi.sub.5" or "LaNi4.5Al0.5" or LaNiAl "LaNi.sub.4.5Al.sub.0.5" or TiZrMnVNi or "La0.88Zr0.12Mn1.0V0.4Ni0.6" or "La.sub.0.88Zr.sub.0.12Mn.sub.1.0V.sub.0.4Ni.sub.0.6" or LaNiMn or "LaNi4.5Mn0.5" or "LaNi.sub.4.5Mn.sub.0.5" or MgNi or Mg2Ni or "Mg.sub.2Ni" or "V" OR Vanadium or zr or zirconium)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/03/27 14:20

L10	44	8 and (cream or paste)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/03/27 14:32
L11	1608876	1 and (remov\$4 or seperat\$4 or separat\$4 or detach\$6 or desolder\$4 or disassembl\$4 or recycl\$4 or resuse or reus\$4 or recover\$4)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/03/27 14:23
L12	109662	11 and (remov\$4 or seperat\$4 or separat\$4 or detach\$6 or desolder\$4 or disassembl\$4 or recycl\$4 or resuse or reus\$4 or recover\$4) near (device or component or chip or package or board or die)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/03/27 14:24
L13	8183	12 and (remov\$4 or seperat\$4 or separat\$4 or detach\$6 or desolder\$4 or disassembl\$4 or recycl\$4 or resuse or reus\$4 or recover\$4) near (individual\$4 or selectiv\$4)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/03/27 14:25
L14	2950	13 and (hydrogen or "h.sub.2" or h2)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/03/27 14:27
L15	492	14 and (remov\$4 or seperat\$4 or separat\$4 or detach\$6 or desolder\$4 or disassembl\$4 or recycl\$4 or resuse or reus\$4 or recover\$4) near (hydrogen or "h. sub.2" or h2)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/03/27 14:26
L16	492	15 and (remov\$4 or seperat\$4 or separat\$4 or detach\$6 or desolder\$4 or disassembl\$4 or recycl\$4 or resuse or reus\$4 or recover\$4) near (hydrogen or "h. sub.2" or h2)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/03/27 14:26

L17	0	16 and (solder\$4 or braz\$4 or filler or adhesive) near ((la or lanthanum or lanthide) near (al or aluminum or ni or nickel) or LaNi or LaNi5 or "LaNi.sub.5" or "LaNi4.5Al0.5" or LaNiAl "LaNi.sub.4.5Al.sub.0.5" or TiZrMnVNi or "La0.88Zr0.12Mn1.0V0.4Ni0.6" or "La.sub.0.88Zr.sub.0.12Mn.sub.1.0V.sub.0.4Ni.sub.0.6" or LaNiMn or "LaNi4.5Mn0.5" or "LaNi.sub.4.5Mn.sub.0.5" or MgNi or Mg2Ni or "Mg.sub.2Ni" or "V" OR Vanadium or zr or zirconium)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/03/27 14:27
L18	257	16 and (hydrogen or "h.sub.2" or h2) near (press\$4 or psi or ksi or pound near inch or pa or pascal or mpa or megapascal)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/03/27 14:29
L19	311	16 and (expand\$4 or expans\$4 or contract\$4 or shrink\$4 or weaken\$4)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/03/27 14:30
L20	214	18 and 19	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/03/27 14:30
L21	0	20 and (cream or paste)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/03/27 14:32